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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, SIO, UART/USART
Peripherals	LED, POR, Voltage Detect, WDT
Number of I/O	13
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-LSSOP (0.173", 4.40mm Width)
Supplier Device Package	20-LSSOP
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21172sp-u0

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

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1.2 Performance Overview

Table 1.1 lists the Performance Outline of the R8C/16 Group and Table 1.2 lists the Performance Outline of the R8C/17 Group.

Table 1.1 Performance Outline of the R8C/16 Group

	Item	Performance
CPU	Number of Basic Instructions	
	Minimum Instruction	50ns(f(XIN)=20MHz, VCC=3.0 to 5.5V)
	Execution Time	100ns(f(XIN)=10MHz, VCC=2.7 to 5.5V)
	Operating Mode	Single-chip
	Address Space	1 Mbyte
	Memory Capacity	See Table 1.3 R8C/16 Group Product Information
Peripheral	Port	I/O port : 13 pins (including LED drive port),
Function		Input: 2 pins
i unction	LED Drive Port	I/O port: 4 pins
	Timer	Timer X: 8 bits × 1 channel, Timer Z: 8 bits × 1 channel
	Timer	
		(Each timer equipped with 8-bit prescaler)
		Timer C: 16 bits x 1 channel
		(Circuits of input capture and output compare)
	Serial Interface	1 channel
		Clock synchronous serial I/O, UART
	I ² C bus Interface (IIC) ⁽¹⁾	1 channel
	A/D Converter	10-bit A/D converter: 1 circuit, 4 channels
	Watchdog Timer	15 bits x 1 channel (with prescaler)
	_	Reset start selectable, Count source protection mode
	Interrupt	Internal: 9 factors, External: 4 factors, Software: 4
	'	factors
		Priority level: 7 levels
	Clock Generation Circuit	2 circuits
	Clock Conclation Chock	Main clock oscillation circuit (Equipped with a built-in
		feedback resistor)
		On-chip oscillator (high speed, low speed)
		Equipped with frequency adjustment function on high-
		speed on-chip oscillator
	Oscillation Stop Detection	Main clock oscillation stop detection function
	Function	
	Voltage Detection Circuit	Included
	Power-on Reset Circuit	Included
Electric	Supply Voltage	VCC=3.0 to 5.5V (f(XIN)=20MHz)
Characteristics		VCC=2.7 to 5.5V (f(XIN)=10MHz)
	Power Consumption	Typ. 9mA (VCC=5.0V, f(XIN)=20MHz)
		Typ. 5mA (VCC=3.0V, f(XIN)=10MHz)
		Typ. 35μA (VCC=3.0V, wait mode, peripheral clock off)
		Typ. 0.7μA (VCC=3.0V, stop mode)
Flash Memory	Program/Erase Supply	VCC=2.7 to 5.5V
,	Voltage	
	Program/Erase Endurance	100 times
Operating Ambi	ent Temperature	-20 to 85°C
	iomporatoro	-40 to 85°C (D Version)
Package		20-pin plastic mold LSSOP
Package		Zu-pin piasilu mulu Loouf

NOTES:

1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.



Table 1.2 Performance Outline of the R8C/17 Group

	Item	Performance
CPU	Number of Basic Instructions	89 instructions
01 0	Minimum Instruction Execution	50ns(f(XIN)=20MHz, VCC=3.0 to 5.5V)
	Time	100ns(f(XIN)=10MHz, VCC=2.7 to 5.5V)
	1	Single-chip
	Operating Mode	
	Address Space	1 Mbyte
Darinharal	Memory Capacity	See Table 1.4 R8C/17 Group Product Information
Peripheral	Port	I/O: 13 pins (including LED drive port),
Function	LED 12 and	Input : 2 pin
	LED drive port	I/O port: 4 pins
	Timer	Timer X: 8 bits x 1 channel, Timer Z: 8 bits x 1 channel
		(Each timer equipped with 8-bit prescaler)
		Timer C: 16 bits x 1 channel
		(Circuits of input capture and output compare)
	Serial Interface	1 channel
		Clock synchronous serial I/O, UART
	I ² C bus Interface (IIC) ⁽¹⁾	1 channel
	A/D Converter	10-bit A/D converter: 1 circuit, 4 channels
	Watchdog Timer	15 bits x 1 channel (with prescaler)
	Ŭ .	Reset start selectable, Count source protection mode
	Interrupt	Internal: 9 factors, External: 4 factors, Software: 4
		factors
		Priority level: 7 levels
	Clock Generation Circuit	2 circuits
	Clock Generation Circuit	Main clock generation circuit (Equipped with a built-in
		, , , , ,
		feedback resistor)
		On-chip oscillator (high speed, low speed)
		Equipped with frequency adjustment function on high-
		speed on-chip oscillator
	Oscillation Stop Detection	Main clock oscillation stop detection function
	Function	
	Voltage Detection Circuit	Included
	Power-on Reset Circuit	Included
Electric	Supply Voltage	VCC=3.0 to 5.5V (f(XIN)=20MHz)
Characteristics		VCC=2.7 to 5.5V (f(XIN)=10MHz)
	Power Consumption	Typ. 9mA (VCC = $5.0V$, $f(XIN) = 20MHz$)
	·	Typ. 5mA (VCC = $3.0V$, $f(XIN) = 10MHz$)
		Typ.35μA (VCC = 3.0V, wait mode, peripheral clock off)
		Typ. $0.7\mu\text{A}$ (VCC = 3.0V, stop mode)
Flash Memory	Program/Erase Supply Voltage	VCC=2.7 to 5.5V
l lasir Memory	Program and Erase	10,000 times (Data flash)
	Endurance	1,000 times (Program ROM)
Operating Ambi		-20 to 85°C
Operating Ambi	ent Temperature	
Dookogo		-40 to 85°C (D Version)
Package		20-pin plastic mold LSSOP

1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.



Table 1.4 Product Information of R8C/17 Group

As of Jan 2006

Type No.	ROM Ca	apacity	RAM	Package Type	Remarks
Type No.	Program ROM	Data flash	Capacity	rackage Type	INGINAINS
R5F21172SP	8 Kbytes	1 Kbyte x 2	512 bytes	PLSP0020JB-A	Flash Memory Version
R5F21173SP	12 Kbytes	1 Kbyte x 2	768 bytes	PLSP0020JB-A	
R5F21174SP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A	
R5F21172DSP	8 Kbytes	1 Kbyte x 2	512 bytes	PLSP0020JB-A	D Version
R5F21173DSP	12 Kbytes	1 Kbyte x 2	768 bytes	PLSP0020JB-A	
R5F21174DSP	16 Kbytes	1 Kbyte x 2	1 Kbyte	PLSP0020JB-A	

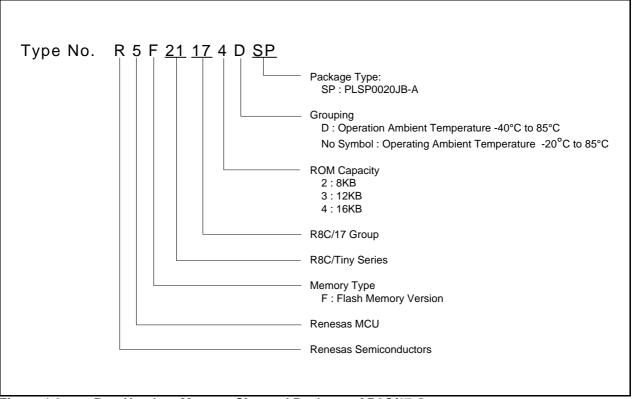


Figure 1.3 Part Number, Memory Size and Package of R8C/17 Group

1.5 Pin Assignments

Figure 1.4 shows the PLSP0020JB-A Package Pin Assignment (top view).

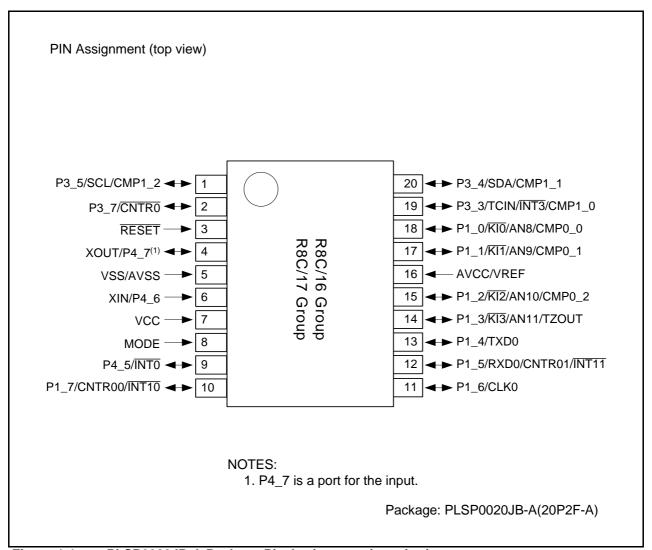


Figure 1.4 PLSP0020JB-A Package Pin Assignment (top view)

Pin Name Information by Pin Number Table 1.6

Pin	Control			I/O Pin of Peripheral Functions					
Number	Pin	Port	Interrupt	Timer	Serial	I ² C bus	A/D Converter		
			ппопарт		Interface	Interface	742 Conventor		
1		P3_5		CMP1_2		SCL			
2		P3_7		CNTR0					
3	RESET								
4	XOUT	P4_7							
5	VSS/AVSS								
6	XIN	P4_6							
7	VCC								
8	MODE								
9		P4_5	ĪNT0						
10		P1_7	ĪNT10	CNTR00					
11		P1_6			CLK0				
12		P1_5	INT11	CNTR01	RXD0				
13		P1_4			TXD0				
14		P1_3	KI3	TZOUT			AN11		
15		P1_2	KI2	CMP0_2			AN10		
16	AVCC/VREF								
17		P1_1	KI1	CMP0_1			AN9		
18		P1_0	KI0	CMP0_0			AN8		
19		P3_3	ĪNT3	TCIN/CMP1_0					
20		P3_4		CMP1_1		SDA			

3. Memory

3.1 R8C/16 Group

Figure 3.1 is a Memory Map of the R8C/16 group. The R8C/16 group provides 1-Mbyte address space from addresses 00000h to FFFFh.

The internal ROM is allocated lower addresses beginning with address 0FFFFh. For example, a 16-Kbyte internal ROM is allocated addresses 0C000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal RAM is allocated higher addresses beginning with address 00400h. For example, a 1-Kbyte internal RAM is allocated addresses 00400h to 007FFh. The internal RAM is used not only for storing data but for calling subroutines and stacks when interrupt request is acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated them. All addresses, which have nothing allocated within the SFR, are reserved area and cannot be accessed by users.

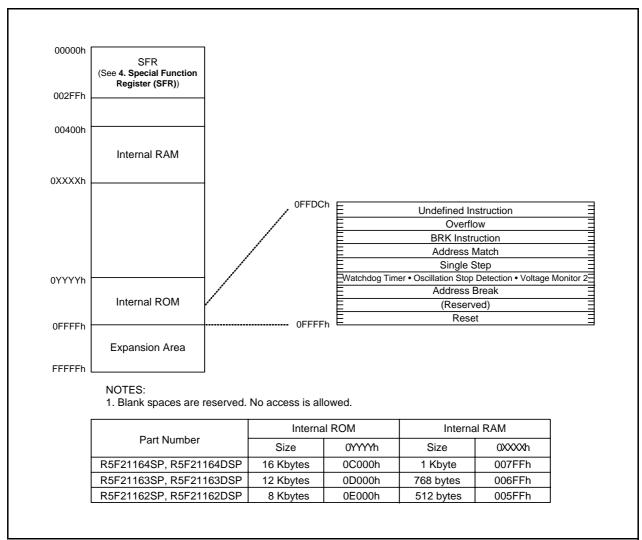


Figure 3.1 Memory Map of R8C/16 Group

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3.2 R8C/17 Group

Figure 3.2 is a memory map of the R8C/17 group. The R8C/17 group provides 1-Mbyte address space from addresses 00000h to FFFFh.

The internal ROM (program ROM) is allocated lower addresses beginning with address 0FFFFh. For example, a 16-Kbyte internal ROM is allocated addresses 0C000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM is allocated higher addresses beginning with address 00400h. For example, a 1-Kbyte internal RAM is allocated addresses 00400h to 007FFh. The internal RAM is used not only for storing data but for calling subroutines and stacks when interrupt request is acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated them. All addresses, which have nothing allocated within the SFR, are reserved area and cannot be accessed by users.

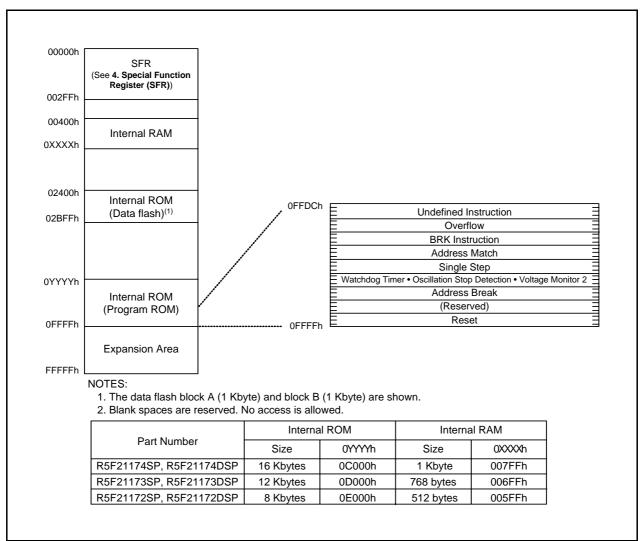


Figure 3.2 Memory Map of R8C/17 Group

4. Special Function Register (SFR)

SFR (Special Function Register) is the control register of peripheral functions. Tables 4.1 to 4.4 list the SFR information.

Table 4.1 SFR Information(1)⁽¹⁾

Address	Pogistor	Cymbal	After Reset
	Register	Symbol	Alter Reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	01101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h			
0009h	Address Match Interrupt Enable Register	AIER	00h
000Ah	Protect Register	PRCR	00h
000Bh	· · · · · · · · · · · · · · · · · · ·		
000Ch	Oscillation Stop Detection register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
		WDC	00011111b
000Fh	Watchdog Timer Control Register		
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h			00h
0012h			X0h
0013h			
0014h	Address Match Interrupt Register 1	RMAD1	00h
0015h			00h
0016h			X0h
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protection Mode Register	CSPR	00h
	Count Source Protection wode Register	COFK	OON
001Dh		INITOE	001-
001Eh	INT0 Input Filter Select Register	INT0F	00h
001Fh			
0020h	High-Speed On-Chip Oscillator Control Register 0	HRA0	00h
0021h	High-Speed On-Chip Oscillator Control Register 1	HRA1	When shipping
0022h	High-Speed On-Chip Oscillator Control Register 2	HRA2	00h
0023h			
002Ah			
002Bh			
002Bh			
002Dh			
002Eh			
002Fh			
0030h			
0031h	Voltage Detection Register 1 ⁽²⁾	VCA1	00001000b
0032h	Voltage Detection Register 2 ⁽²⁾	VCA2	00h ⁽³⁾
	-		01000000b ⁽⁴⁾
0033h			
0034h			
0034H			
0035h	Voltage Manites 4 Circuit Control Degister (2)	VW1C	000000006(3)
003011	Voltage Monitor 1 Circuit Control Register (2)	V VV 10	0000X000b ⁽³⁾
			0100X001b ⁽⁴⁾
0037h	Voltage Monitor 2 Circuit Control Register (5)	VW2C	00h
0038h			
0039h			
003Ah			
003Bh			
003Ch			
003Ch			
003Dh			
003Fh			

X: Undefined

- 1. Blank spaces are reserved. No access is allowed.
- 2. Software reset, the watchdog timer reset or the voltage monitor 2 reset does not affect this register.
- 3. Owing to Hardware reset.
- 4. Owing to Power-on reset or the voltage monitor 1 reset.
- 5. Software reset, the watchdog timer reset or the voltage monitor 2 reset does not affect the b2 and b3.



SFR Information(3)(1) Table 4.3

Address	Register	Symbol	After Reset
0080h	Timer Z Mode Register	TZMR	00h
0081h		1	
0082h			
0083h			
0084h	Timer Z Waveform Output Control Register	PUM	00h
0085h	Prescaler Z Register	PREZ	FFh
0086h	Timer Z Secondary Register	TZSC	FFh
0087h	Timer Z Primary Register	TZPR	FFh
0087h	Timer 2 Filmary Register	IZFK	
0089h			
008Ah	Timer Z Output Control Register	TZOC	00h
		TXMR	
008Bh	Timer X Mode Register		00h
008Ch	Prescaler X Register	PREX	FFh
008Dh	Timer X Register	TX	FFh
008Eh	Timer Count Source Setting Register	TCSS	00h
008Fh			
0090h	Timer C Register	TC	00h
0091h			00h
0092h			
0093h			
0094h			
0095h			
0096h	External Input Enable Register	INTEN	00h
0097h	-		
0098h	Key Input Enable Register	KIEN	00h
0099h	, , ,		
009Ah	Timer C Control Register 0	TCC0	00h
009Bh	Timer C Control Register 1	TCC1	00h
009Ch	Capture, Compare 0 Register	TMO	00h
009Dh	- Capture, Compare o Register	TWO	00h ⁽²⁾
	Company 4 Desister	TNA	
009Eh	Compare 1 Register	TM1	FFh
009Fh	1110707	110.15	FFh
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UART0 Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h			XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00A7h	7		XXh
00A8h			
00A9h	†		
00AAh			
00ABh			
00ABh 00ACh			
00ACh 00ADh			
00ACh 00ADh 00AEh			
00ACh 00ADh 00AEh 00AFh	UART Transmit/Receive Control Register 2	LICON	00h
00ACh 00ADh 00AEh 00AFh 00B0h	UART Transmit/Receive Control Register 2	UCON	00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h	UART Transmit/Receive Control Register 2	UCON	00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h	UART Transmit/Receive Control Register 2	UCON	00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h	UART Transmit/Receive Control Register 2	UCON	00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h	UART Transmit/Receive Control Register 2	UCON	00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h	UART Transmit/Receive Control Register 2	UCON	00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h	UART Transmit/Receive Control Register 2	UCON	00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h			
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B6h 00B6h 00B7h	IIC bus Control Register 1	ICCR1	00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h	IIC bus Control Register 1 IIC bus Control Register 2	ICCR1 ICCR2	00h 7Dh
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00B8h	IIC bus Control Register 1 IIC bus Control Register 2 IIC bus Mode Register	ICCR1 ICCR2 ICMR	00h 7Dh 18h
00ACh 00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00B9h 00BAh	IIC bus Control Register 1 IIC bus Control Register 2 IIC bus Mode Register IIC bus Interrupt Enable Register	ICCR1 ICCR2	00h 7Dh 18h 00h
00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00B8h	IIC bus Control Register 1 IIC bus Control Register 2 IIC bus Mode Register	ICCR1 ICCR2 ICMR	00h 7Dh 18h
00ACh 00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00B9h 00BAh	IIC bus Control Register 1 IIC bus Control Register 2 IIC bus Mode Register IIC bus Interrupt Enable Register	ICCR1 ICCR2 ICMR ICIER	00h 7Dh 18h 00h
00ACh 00ACh 00ADh 00AEh 00AFh 00B0h 00B1h 00B3h 00B3h 00B6h 00B7h 00B8h 00B9h 00BAh 00BBh 00BAh	IIC bus Control Register 1 IIC bus Control Register 2 IIC bus Mode Register IIC bus Interrupt Enable Register IIC bus Status Register	ICCR1 ICCR2 ICMR ICIER ICSR	00h 7Dh 18h 00h 00h

X: Undefined

- Blank spaces are reserved. No access is allowed.
 When output compare mode (the TCC13 bit in the TCC1 register = 1) is selected, the value after reset is "FFFFh".

SFR Information(4)⁽¹⁾ Table 4.4

Address	Register	Symbol	After reset
00C0h	A/D Register	AD	XXh
00C1h	-		XXh
00C2h			
00C3h			
00C4h			
00C5h 00C6h			
00C6H			
00C8h			_
00C9h			
00CAh			
00CBh			
00CCh			
00CDh			
00CEh			
00CFh			
00D0h			
00D1h			
00D2h 00D3h			
00D3H 00D4h	A/D Control Register 2	ADCON2	00h
00D5h	77D Control Negloter 2	/ LDOOINZ	5511
00D6h	A/D Control Register 0	ADCON0	00000XXXb
00D7h	A/D Control Register 1	ADCON1	00h
00D8h	•		1
00D9h			
00DAh			
00DBh			
00DCh			
00DDh			
00DEh 00DFh			
00E0h			
00E1h	Port P1 Register	P1	XXh
00E2h	3		75
00E3h	Port P1 Direction Register	PD1	00h
00E4h			
00E5h	Port P3 Register	P3	XXh
00E6h			
00E7h	Port P3 Direction Register	PD3	00h
00E8h 00E9h	Port P4 Register	P4	XXh
00EAh	Port P4 Direction Register	PD4	00h
00EBh			
00ECh			
00EDh			
00EEh			
00EFh			
00F0h			
00F1h			<u> </u>
00F2h 00F3h		1	+
00F4h		1	
00F5h		1	+
00F6h		1	+
00F7h		†	
00F8h			
00F9h			
00FAh			
00FBh		Buba	
00FCh	Pull-Up Control Register 0	PUR0	00XX0000b
00FDh 00FEh	Pull-Up Control Register 1 Port P1 Drive Capacity Control Register	PUR1 DRR	XXXXXX0Xb 00h
00FEn	Timer C Output Control Register	TCOUT	00h
001111	Times o output control register	1.0001	10011
01B3h	Flash Memory Control Register 4	FMR4	01000000b
01B4h	, ,	1	
01B5h	Flash Memory Control Register 1	FMR1	1000000Xb
01B6h			
01B7h	Flash Memory Control Register 0	FMR0	00000001b
0FFFFh	Optional Function Select Register	OFS	T(2)
VIIFFII	Optional i unotion delect register	0.3	(2)

X: Undefined NOTES:

- Blank columns, 0100h to 01B2h and 01B8h to 02FFh are all reserved. No access is allowed.
 The OFS register cannot be changed by program. Use a flash programmer to write to it.

Table 5.4 Flash Memory (Program ROM) Electrical Characteristics

Cymbal	Parameter	Conditions	;	Standard		Unit
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
_	Program/Erase Endurance ⁽²⁾	R8C/16 Group	100(3)	-	-	times
		R8C/17 Group	1,000(3)	=	_	times
=	Byte Program Time	Vcc = 5.0 V at Topr = 25 °C	=	50	400	μS
=	Block Erase Time	Vcc = 5.0 V at Topr = 25 °C	-	0.4	9	S
td(SR-ES)	Time Delay from Suspend Request until Erase Suspend		=	=	8	ms
_	Erase Suspend Request Interval		10	_	_	ms
_	Program, Erase Voltage		2.7	-	5.5	V
_	Read Voltage		2.7	_	5.5	V
=	Program, Erase Temperature		0	-	60	°C
=	Data Hold Time ⁽⁷⁾	Ambient temperature = 55 °C	20	-	=	year

- 1. Vcc = AVcc = 2.7 to 5.5V at $T_{opr} = 0$ to 60 °C, unless otherwise specified.
- 2. Definition of program and erase
 - The program and erase endurance shows an erase endurance for every block.
 - If the program and erase endurance is "n" times (n = 100, 10000), "n" times erase can be performed for every block.
 - For example, if performing 1-byte write to the distinct addresses on Block A of 1Kbyte block 1,024 times and then erasing that block, program and erase endurance is counted as one time.
 - However, do not perform multiple programs to the same address for one time ease.(disable overwriting).
- 3. Endurance to guarantee all electrical characteristics after program and erase.(1 to "Min." value can be guaranateed).
- 4. In the case of a system to execute multiple programs, perform one erase after programming as reducing effective reprogram endurance not to leave blank area as possible such as programming write addresses in turn. If programming a set of 16 bytes, programming up to 128 sets and then erasing them one time can reduce effective reprogram endurance. Additionally, averaging erase endurance for Block A and B can reduce effective reprogram endurance more. To leave erase endurance for every block as information and determine the restricted endurance are recommended.
- 5. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error does not occur.
- 6. Customers desiring Program/Erase failure rate information should contact their Renesas technical support representative.
- 7. The data hold time incudes time that the power supply is off or the clock is not supplied.

Table 5.5 Flash Memory (Data flash Block A, Block B) Electrical Characteristics

Cumbal	Parameter	Conditions	5	Standard		Unit
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
=	Program/Erase Endurance ⁽²⁾		10,000(3)	=	=	times
=	Byte Program Time (Program/Erase Endurance ≤ 1,000 Times)	Vcc = 5.0 V at Topr = 25 °C	=	50	400	μS
	Byte Program Time (Program/Erase Endurance > 1,000 Times)	Vcc = 5.0 V at Topr = 25 °C	-	65	-	μS
	Block Erase Time (Program/Erase Endurance ≤ 1,000 Times)	Vcc = 5.0 V at Topr = 25 °C	=	0.2	9	S
-	Block Erase Time (Program/Erase Endurance > 1,000 Times)	Vcc = 5.0 V at Topr = 25 °C	=	0.3	-	S
td(SR-ES)	Time Delay from Suspend Request until Erase Suspend		=	=	8	ms
_	Erase Suspend Request Interval		10	-	_	ms
_	Program, Erase Voltage		2.7	-	5.5	V
_	Read Voltage		2.7	-	5.5	V
-	Program, Erase Temperature		-20(8)	-	85	°C
_	Data Hold Time ⁽⁹⁾	Ambient temperature = 55 °C	20	-	_	year

- 1. Vcc = AVcc = 2.7 to 5.5V at Topr = -20 to 85 °C / -40 to 85 °C, unless otherwise specified.
- 2. Definition of program and erase

The program and erase endurance shows an erase endurance for every block.

If the program and erase endurance is "n" times (n = 100, 10000), "n" times erase can be performed for every block. For example, if performing 1-byte write to the distinct addresses on Block A of 1Kbyte block 1,024 times and then erasing that block, program and erase endurance is counted as one time.

However, do not perform multiple programs to the same address for one time ease. (disable overwriting).

- 3. Endurance to guarantee all electrical characteristics after program and erase.(1 to "Min." value can be guaranateed).
- 4. Standard of Block A and Block B when program and erase endurance exceeds 1,000 times. Byte program time to 1,000 times are the same as that in program area.
- 5. In the case of a system to execute multiple programs, perform one erase after programming as reducing effective reprogram endurance not to leave blank area as possible such as programming write addresses in turn. If programming a set of 16 bytes, programming up to 128 sets and then erasing them one time can reduce effective reprogram endurance. Additionally, averaging erase endurance for Block A and B can reduce effective reprogram endurance more. To leave erase endurance for every block as information and determine the restricted endurance are recommended.
- 6. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error does not occur.
- 7. Customers desiring Program/Erase failure rate information should contact their Renesas technical support representative.
- 8. -40 °C for D version.
- 9. The data hold time incudes time that the power supply is off or the clock is not supplied.

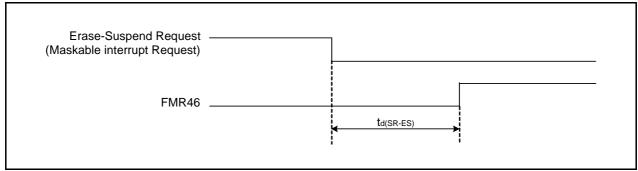


Figure 5.2 Time delay from Suspend Request until Erase Suspend

Table 5.6 Voltage Detection 1 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Standard	Max. 3.00	Unit
Syllibol	Falantelei	Condition	Min.	Тур.	Max.	Offic
Vdet1	Voltage Detection Level ⁽³⁾		2.70	2.85	3.00	V
=	Voltage Detection Circuit Self Power Consumption	VCA26 = 1, Vcc = 5.0V	=	600	=	nA
td(E-A)	Waiting Time until Voltage Detection Circuit Operation Starts ⁽²⁾		=	=	100	μS
Vccmin	Microcomputer Operating Voltage Minimum Value		2.7	-	-	V

- 1. The measurement condition is Vcc = AVcc = 2.7V to 5.5V and $T_{opr} = -40^{\circ}C$ to 85 °C.
- 2. Necessary time until the voltage detection circuit operates when setting to "1" again after setting the VCA26 bit in the VCA2 register to "0".
- 3. Hold Vdet2 > Vdet1.

Table 5.7 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Standard	Max. 3.60	Unit
Syllibol	Farameter	Condition	Min.	Тур.	Max.	Offic
Vdet2	Voltage Detection Level ⁽⁴⁾		3.00	3.30	3.60	V
_	Voltage Monitor 2 Interrupt Request Generation Time ⁽²⁾		_	40	-	μS
=	Voltage Detection Circuit Self Power Consumption	VCA27 = 1, Vcc = 5.0V	=	600	-	nA
td(E-A)	Waiting Time until Voltage Detection Circuit Operation Starts ⁽³⁾		Î	-	100	μS

- 1. The measurement condition is VCC = AVCC = 2.7V to 5.5V and Topr = -40 $^{\circ}$ C to 85 $^{\circ}$ C.
- 2. Time until the voltage monitor 2 interrupt request is generated since the voltage passes Vdet1.
- 3. Necessary time until the voltage detection circuit operates when setting to "1" again after setting the VCA27 bit in the VCA2 register to "0".
- 4. Hold Vdet2 > Vdet1.



Table 5.8 Reset Circuit Electrical Characteristics (When Using Voltage Monitor 1 Reset)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Тур.	Max.	
Vpor2	Power-On Reset Valid Voltage	$-20^{\circ}C \leq Topr < 85^{\circ}C$	=	=	Vdet1	V
tw(Vpor2-Vdet1)	Supply Voltage Rising Time When Power-On Reset is	-20°C ≤ Topr < 85°C,	-	-	100	ms
	Deasserted ⁽¹⁾	$t_{w(por2)} \ge 0s(3)$				

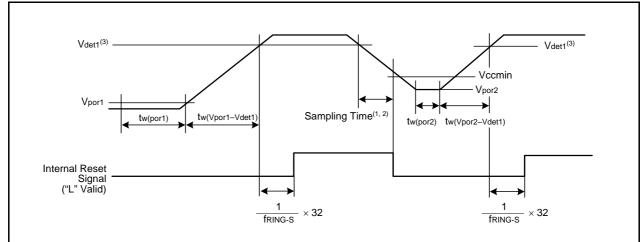
- 1. This condition is not applicable when using with $Vcc \ge 1.0V$.
- When turning power on after the time to hold the external power below effective voltage (Vport) exceeds10s, refer to Table
 S.9 Reset Circuit Electrical Characteristics (When Not Using Voltage Monitor 1 Reset).
- 3. tw(por2) is time to hold the external power below effective voltage (Vpor2).

Table 5.9 Reset Circuit Electrical Characteristics (When Not Using Voltage Monitor 1 Reset)

Symbol	Parameter Condition			Unit		
			Min.	Тур.	Max.	
Vpor1	Power-On Reset Valid Voltage	$-20^{\circ}C \leq Topr < 85^{\circ}C$	=	=	0.1	V
tw(Vpor1-Vdet1)	Supply Voltage Rising Time When Power-On Reset is Deasserted	$0^{\circ}C \leq Topr \leq 85^{\circ}C,$ $tw(por1) \geq 10s^{(2)}$	-	=	100	ms
tw(Vpor1-Vdet1)	Supply Voltage Rising Time When Power-On Reset is Deasserted	$\label{eq:continuous} \begin{split} -20^{\circ}C &\leq Topr < 0^{\circ}C, \\ tw(por1) &\geq 30s^{(2)} \end{split}$	-	=	100	ms
tw(Vpor1-Vdet1)	Supply Voltage Rising Time When Power-On Reset is Deasserted	$\begin{aligned} -20^{\circ}C &\leq Topr < 0^{\circ}C, \\ tw(por1) &\geq 10s^{(2)} \end{aligned}$	_	_	1	ms
tw(Vpor1-Vdet1)	Supply Voltage Rising Time When Power-On Reset is Deasserted	$0^{\circ}C \leq Topr \leq 85^{\circ}C,$ $tw(por1) \geq 1s^{(2)}$	_	_	0.5	ms

NOTES:

- 1. When not using the voltage monitor 1 reset, use with Vcc≥ 2.7V.
- 2. tw(por1) is time to hold the external power below effective voltage (Vpor1).



- Hold the voltage of the microcomputer operation voltage range (Vccmin or above) within sampling time.
- 2. A sampling clock can be selected. Refer to 6. Voltage Detection Circuit of Hardware Manual for details.
- Vdet1 indicates the voltage detection level of the voltage detection 1 circuit. Refer to 6. Voltage Detection Circuit of Hardware Manual for details.

Figure 5.3 Reset Circuit Electrical Characteristics

Electrical Characteristics (2) [Vcc = 5V] (Topr = -40 to 85 $^{\circ}$ C, unless otherwise specified.) **Table 5.14**

Symbol	Parameter	Condition			Unit		
Symbol	Faiailielei		Condition	Min.	Тур.	Max.	Offic
Icc	Power Supply Current (Vcc=3.3 to 5.5V) In single-chip mode, the output pins are open and other pins are Vss	High-Speed Mode	XIN = 20MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz No division	_	9	15	mA
			XIN = 16MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz No division	_	8	14	mA
			XIN = 10MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz No division	_	5	_	mA
		Medium- Speed Mode	XIN = 20MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz Divide-by-8	_	4	-	mA
			XIN = 16MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz Divide-by-8	_	3	-	mA
			XIN = 10MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz Divide-by-8	_	2	_	mA
		High-Speed On-Chip Oscillator Mode	Main clock off High-speed on-chip oscillator on=8MHz Low-speed on-chip oscillator on=125kHz No division	_	4	8	mA
			Main clock off High-speed on-chip oscillator on=8MHz Low-speed on-chip oscillator on=125kHz Divide-by-8	_	1.5	-	mA
		Low-Speed On-Chip Oscillator Mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz Divide-by-8	_	470	900	μА
		Wait Mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz While a WAIT instruction is executed Peripheral clock operation VCA26 = VCA27 = 0	-	40	80	μА
		Wait Mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on=125kHz While a WAIT instruction is executed Peripheral clock off VCA26 = VCA27 = 0	_	38	76	μА
		Stop Mode	Main clock off, Topr = 25 °C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	=	0.8	3.0	μА

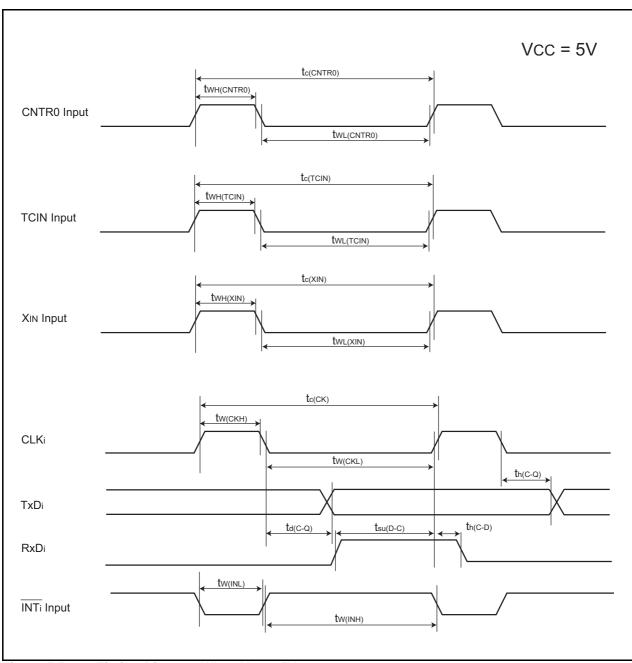


Figure 5.5 Timing Diagram When Vcc = 5V

Electrical Characteristics (3) [Vcc = 3V] **Table 5.20**

Symbol	Parameter		Condition		Standard			Unit
Symbol					Min.	Тур.	Max.	Unit
Vон	Output "H" Voltage	Except Xout	IOH = -1mA		Vcc - 0.5	_	Vcc	V
		Хоит	Drive capacity HIGH	Iон = -0.1mA	Vcc - 0.5	-	Vcc	V
			Drive capacity LOW	IOH = -50μA	Vcc - 0.5	-	Vcc	V
VoL Output "L" Volta		Except P1_0 to P1_3, Xout	IoL = 1mA		=	=	0.5	V
		P1_0 to P1_3	Drive capacity HIGH	IOL = 2mA	_	_	0.5	V
			Drive capacity LOW	IOL = 1mA	_	_	0.5	V
		Хоит	Drive capacity HIGH	IOL = 0.1mA	=	-	0.5	V
			Drive capacity LOW	IOL = 50μA	=	=	0.5	V
VT+-VT-	Hysteresis	INTO, INT1, INT3, KIO, KI1, KI2, KI3, CNTR0, CNTR1, TCIN, RXD0			0.2	-	0.8	V
		RESET			0.2	_	1.8	V
Iн	Input "H" Current		VI = 3V		-	_	4.0	μΑ
lıL	Input "L" Current		VI = 0V		-	-	-4.0	μΑ
RPULLUP	Pull-Up Resistance		VI = 0V		66	160	500	kΩ
RfXIN	Feedback Resistance	XIN			-	3.0	_	МΩ
fring-s	Low-Speed On-Chip Oscillator Frequency				40	125	250	kHz
VRAM	RAM Hold Voltage		During stop mode		2.0	-	-	V

^{1.} Vcc = AVcc = 2.7 to 3.3V at Topr = -20 to 85 °C / -40 to 85 °C, f(XIN)=10MHz, unless otherwise specified.

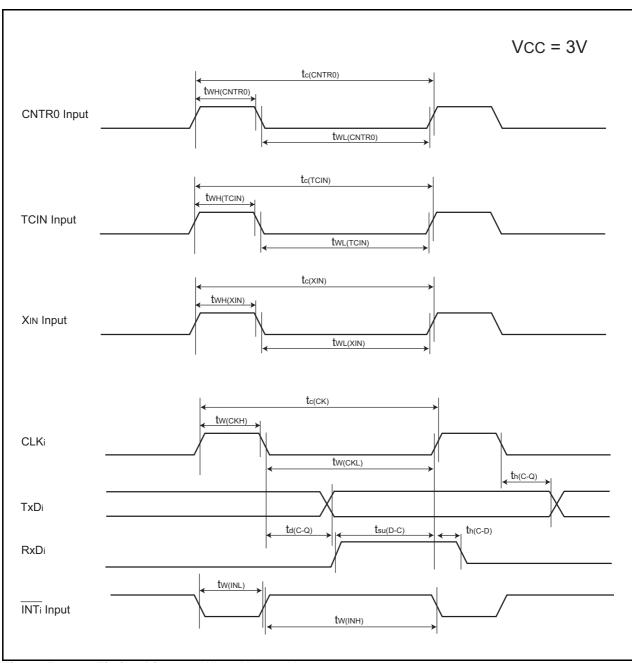


Figure 5.6 Timing Diagram When Vcc = 3V

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Rev. Date			Description
Rev.	Dale	Page	Summary
2.00	Jan 30, 2006	8	Figure 1.5 PRDP0020BA-A Package Pin Assignment (top view) deleted Table 1.5 Pin Description; Timer C: "CMP0_0 to CMP0_3, CMP1_0 to CMP1_3" →
		10	"CMP0_0 to CMP0_2, CMP1_0 to CMP1_2" revised Figure 2.1 CPU Register; "Reserved Area" → "Reserved Bit" revised
		12	2.8.10 Reserved Area; "Reserved Area" → "Reserved Bit" revised
		13	Figure 3.1 Memory Map of R8C/16 Group revised
		14	3.2 R8C/17 Group;
		17	<pre>(program area) → (program ROM), (data area) → (data flash) revised Figure 3.2 Memory Map of R8C/17 Group revised Table 4.3 SFR Information(3); 0085h: "Prescaler Z" → "Prescaler Z Register"</pre>
			0086h: "Timer Z Secondary" → "Timer Z Secondary Register" 0087h: "Timer Z Primary" → "Timer Z Primary Register" 008Ch: "Prescaler X" → "Prescaler X Register" 008Dh: "Timer X" → "Timer X Register" 0090h, 0091h: "Timer C" → "Timer C Register" revised
		21	Table 5.4 Flash Memory (Program ROM) Electrical Characteristics; • NOTES 1 to 7 added • "Topr" → "Ambient temperature", "(Program area)" → "(Program ROM)" revised
		22	Table 5.5 Flash Memory (Data flash Block A, Block B) Electrical Characteristics; • NOTE1 revised, NOTE9 added • "Topr" → "Ambient temperature", "(Program area)" → "(Program ROM)" revised
		23	Figure 5.2 Time delay from Suspend Request until Erase Suspend revised Table 5.7 Voltage Detection 2 Circuit Electrical Characteristics; NOTE1 revised
		24	Table 5.8 Reset Circuit Electrical Characteristics (When Using Voltage Monitor 1 Reset); NOTE2 revised Table 5.9 Reset Circuit Electrical Characteristics (When Not Using Voltage
		25	Monitor 1 Reset); NOTE1 revised Table 5.10 High-speed On-Chip Oscillator Circuit Electrical Characteristics revised
		26	Table 5.12 Timing Requirements of I2C bus Interface (IIC); NOTE1 revised
		28	Table 5.14 Electrical Characteristics (2) [Vcc = 5V] revised
		29	"Timing Requirements (Unless at Ta = 25°C) [VCC = 5V]" \rightarrow "Timing Requirements (Unless at Topr = 25°C) [VCC = 5V]" revised Table 5.18 Serial Interface; "35" \rightarrow "50", "80" \rightarrow "50"
		32	Table 5.21 Electrical Characteristics (4) [Vcc = 3V] revised
		33	"Timing requirements (Unless at Ta = 25°C) [VCC = 3V]" → "Timing requirements (Unless at Topr = 25°C) [VCC = 3V]" revised Table 5.25 Serial Interface; "55" → "70", "160" → "70"
		35	Package Dimensions; Package "PRDP0020BA-A" deleted